GIULIANO SISTOM







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ABOUT ME

I am an enthusiastic SoC Researcher, with Physical Design expertise and a keen eye for design methodologies. I thrive in contexts where "what?" is always followed by "how?". Currently, I am looking for a chance to boost my knowledge on Computer Architectures while leveraging my expertise in SoC design. My ambition is to steer the semiconductor industry towards the path of Architecture-Design Co-Optimization, as I strongly believe that it will be a key enabler for next generation digital ICs.

EDUCATION

Doctor of Philosophy (PhD), Electrical Engineering

Ecole polytechnique de Bruxelles - Université Libre de Bruxelles

- **Oct** 2018 2022(expected)
- Leuven, BE
- Thesis: "Design Enablement of integrated circuts using sub-5nm technology process and 3D integration"
- Guest lecturer ETH Zurich, Politecnico di Bari

Exchange Student, Electronic Systems

Department of Electrical Engineering - Technology University of Eindhoven

Feb 2017 - July 2017

■ Eindhoven, NL

MSc, Electrical Engineering, Micro Electronics Systems

Dipartimento di Ingegneria Elettrica e dell'informazione - Politecnico di Bari

a Jan 2016 - Jul 2018

Bari, IT

EXPERIENCE

Researcher

IMEC

Nov 2021 - Present

Leuven, BE

PhD Candidate

Cadence Design Systems - IMEC

- Oct 2018 2021
- Leuven, BE
- Proposal and implementation of new methods to enable advanced technologies for front-end and back-end digital IC design
- Advanced CMOS technology nodes (sub-5nm FinFET GAAFET CFET) and 3D-IC
- Industrial design benchmarking: ARM RISC-V NVDLA
- European project technical lead for 2nm technology node research

Engineering Internship

Huawei Technologies

Feb 2018 - Jul 2018

Sophia-Antipolis, FR

- Architecture design and physical implementation of digital filters for All Digital PLLs

TECHNICAL SKILLS

TCL Bash

Linux Verilog, VHDL

Python Git

Matlab



SOFT SKILLS

Resilience Problem solving
Project management Empathy
Affinity to learn Team player
Public Speaking/Presenting

LANGUAGES

Italian English French Dutch



AWARDS

♠ ERASMUS+ for Traineeship Scholarship

TUCEP

2018

Bari,IT

INTERESTS

Videogames Board/Card games

eSports Soccer Cinema

Travel Music

LIST OF PUBLICATIONS

- G.Sisto*, et al., "Evaluation of Nanosheet and Forksheet Width Modulation for Digital IC Design in the Sub-3nm Era", IEEE
 Transactions on Very Large Scale Integration (VLSI) Systems, vol. 30, no. 10, pp. 1497-1506, Oct. 2022
- R.Chen, **G.Sisto***, et al., "Design and Optimization of SRAM Macro and Logic Using Backside Interconnects at 2nm Node", IEDM 2021, San Francisco, USA (*authors contributed equally to the work)
- **G.Sisto** et al., "Design And Sign-off Methodologies For Wafer-To-Wafer Bonded 3D-ICs At Advanced Nodes (invited)", SLIP 2021 (co-hosted with ICCAD 2021), Virtual Event
- **G.Sisto** et al., "IR-Drop Analysis of Hybrid Bonded 3D-ICs with Backside Power Delivery and μ & n- TSVs", IITC 2021, Kyoto, Japan
- **G.Sisto** et al., "Design enablement of fine pitch face-to-face 3D system integration using die-by-die place & route", 3DIC 2019, Sendai, Japan